

Variable	Mean	Standard Deviation	Minimum	Maximum
Age	34.5	10.2	22	55
Gender	0.5	0.5	0	1
Marital Status	0.6	0.5	0	1
Education	12.5	1.5	10	16
Income	3500	1500	1000	8000
Health	0.8	0.2	0	1
Stress	4.5	1.5	1	7
Depression	2.5	1.0	1	5
Life Satisfaction	5.5	1.0	1	7
Work Satisfaction	4.0	1.0	1	5
Family Satisfaction	5.0	1.0	1	6
Community Satisfaction	4.5	1.0	1	6
Overall Satisfaction	4.8	1.0	1	6

As a below named inventor, I hereby declare that:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **POWER MOSFET AND METHOD FOR FORMING SAME USING A SELF-ALIGNED BODY IMPLANT**, the specification of which:

X\_\_ is attached hereto

as Application Serial No. \_\_\_\_\_

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulation, 1.56(a).

I hereby claim priority benefits under Title 35, United States Code, 119, of any United States application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the date of the application on which priority is claimed:

Prior U.S. (Provisional) Application:

Priority Claimed

60/219,858

July 20, 2000

[ X ]

[ ]

(Number)

Yes

No

I hereby claim the benefit under Title 35, United States Code, 120, of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln Serial No.)

(Filing Date)

(Status)

(patented, pending, aban.)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

#### English Language Declaration

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorneys to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: **Stephen C. Schott**, Reg. No. 42,131, Fairchild Semiconductor Corporation, 82 Running Hill Road, MS 35-4E, South Portland, Maine 04106; and **Christopher F. Regan**, Reg. No. 34,906; **Herbert L. Allen**, Reg. No. 25,322; **David L. Sigalow**, Reg. No. 36,006; **Jeffrey S. Whittle**, Reg. No. 36,382; **Richard K. Warther**, Reg. No. 32,180; **Michael W. Taylor**, Reg. No. 43,182; **Henry Estevez**, Reg. No. 37,823; **Paul J. Ditmyer**, Reg. No. 40,455; **John F. Woodson, II**, Reg. No. 45,236; **Charles E. Wands**, Reg. No. 25,649; **Jacqueline E. Hartt**, Reg. No. 37,845; **Mark R. Malek**, Reg. No. 46,894; **Richard A. Hinson**, Reg. No. P-47,652, all of Allen, Dyer, Doppelt, Milbrath & Gilchrist, P.A., P.O. Box 3791, Orlando, FL 32802-3791.

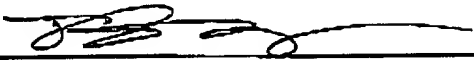
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